

Arctis Cryo-Plasma-FIB

Automation, throughput and connectivity for the cryo-electron tomography workflow

thermo scientific

Take the next step

The Thermo Scientific[™] Arctis[™] Cryo-Plasma-FlB automates high-throughput TEM lamellae production and features Autoloader connectivity for the cryo-electron tomography workflow.

Plasma focused ion beam provides multiple ion species (xenon, oxygen, argon) for high-quality lamella preparation without gallium implantation. Obtain outstanding performance for large volume material removal and precision milling.



System enclosure, designed with biosafety in mind, protects the microscope assembly from the laboratory environment and is equipped with an integrated service hoist. Robotic sample handling for up to — 12 grids and direct connectivity to cryo-TEMs with **Autoloader**. Precise and stable sample manipulation with **CompuStage**. **TomoGrids** for optimal alignment of cryo-lamellae to the tomographic tilt axis.

Thermo Scientific iFLM Correlative System – Fluorescence microscope for targeting lamellae sites without moving the stage. Enables imaging at the electron/ion beam coincidence point.

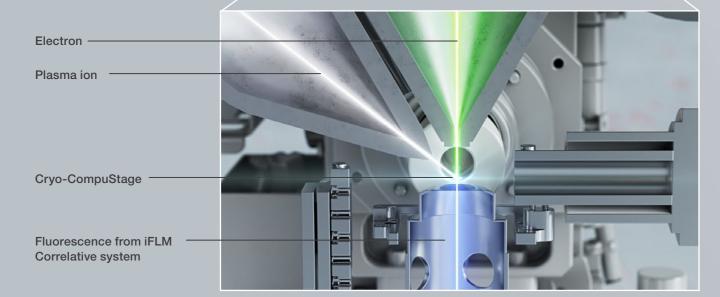
Scanning electron microscope

optimized for high resolution and beam stability. Enables sample navigation, targeting of the region of interest, and precise end-pointing for cryo-lamella preparation.

Correlation to light microscopy

"On-board" integrated fluorescence light microscope (iFLM) allows the same area to be observed with light, ion, or electron beams.







Fluorescence imaging for targeting, intermediate verification, and final target confirmation can easily be done before, in-between, and after ion milling without moving the stage.

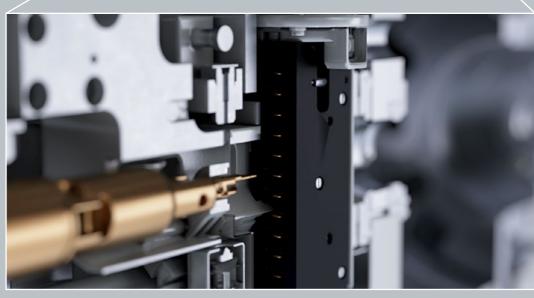
Transform your workflow

Autoloader

System setup can be performed remotely. Lamella milling is automated and can be monitored from anywhere.









Cryo CompuStage (top right) tilts 180* to image the top and bottom of thick samples. The robotic arm of the Autoloader (top left) provides easy and robust transfer of 12 grids at a time from an Autoloader cassette (bottom left) avoiding unnecessary manual handling and ensuring consistency.



"One of the things that I find exciting about Arctis [Cryo-PFIB] is the degree to which it is an automated workflow. And so, this ability to have it running essentially unsupervised and produce high quality, large numbers of lamella is transformational." –Jim Naismith Director of The Rosalind Franklin Institute

Connected cryo-electron tomography workflow

Specially designed TomoGrids always ensure correct lamella alignment to the tomographic tilt axis, from initial milling through high-resolution TEM imaging. The direct connection to any Autoloader-equipped cryo-TEM (e.g.,Thermo Scientific Krios™ or Glacios™ Cryo-TEMs) eliminates manual grid handling and transfer steps between FIB-SEM and TEM.

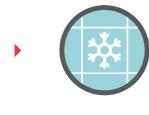


Thermo Scientific Vitrobot[™] System

Thermo Scientific Arctis Cryo-Plasma-FIB



Cell culture

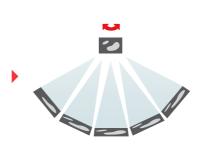


Sample preparation by vitrification



Localization by fluorescence

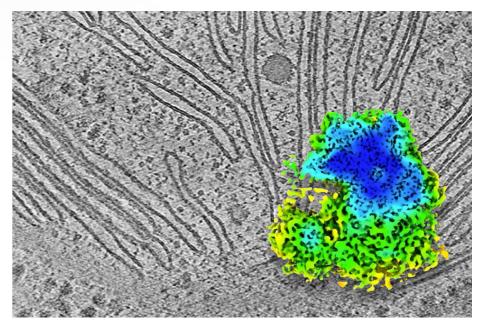
Thinning by milling

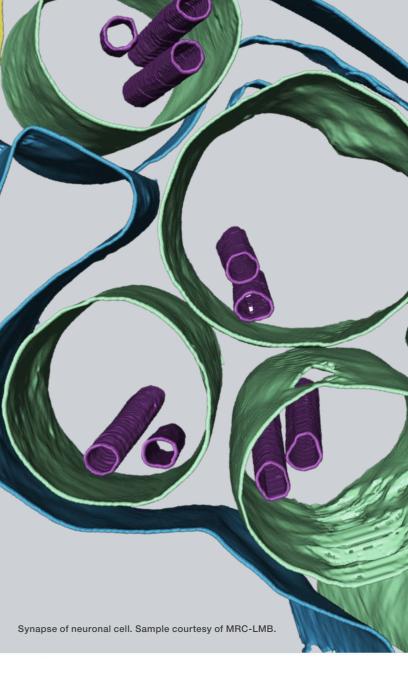


Thermo Scientific

Krios Cryo-TEM

Imaging by TEM, Tomography 5, and Tomo Live Software





Reconstruction and visualization of ribosome from Chlamydomonas

High-quality lamellae with consistent thickness

Reliable control of thickness significantly increases throughput, saves time, and gives you confidence in the quality of your final lamellae. An ultra-clean working environment is ensured for multiple days through the proven combination of a compact sample chamber and a dedicated cryo-box for shielding against water condensation.



lon optics		
•	High parformance PEIP column with inductively coupled plasma (ICP) course for fact ion quitabil	
lon gun	High-performance PFIB column, with inductively coupled plasma (ICP) source for fast ion switch	
lon species	Xenon, argon, oxygen	
Switching time	<10 minutes, only software operation	
Beam current range	1.5 pA to 2.5 μA	
Accelerating voltage range	0.5–30 kV	
Maximum horizontal field width	0.9 mm at beam coincidence point	
Resolution (Xe+ beam)	<20 nm at 30 kV	
Electron optics		
Electron gun	High-stability Schottky field emission gun	
Column	UHR non-immersion field-emission SEM column	
Source lifetime	Minimum 12 months	
Gun maintenance	Auto bakeout, auto start and no mechanical alignments	
	Continuous beam current control and optimized aperture angle	
Beam current range	1.5 pA to 400 nA	
Accelerating voltage range	0.2–30 kV	
Detectors	In-lens detection system: T1 (BSE) and T2 (SE) / In-chamber: ETD (SE)	
Resolution (T2)	<2.6 nm at 2 kV	
Fluorescence microscope		
Coincidence point	Triple beam coincidence at sample position for photons, electrons, and ions	
Objective	100x Zeiss Epiplan Neofluar NA 0.75; Piezo-driven	
Objective working distance	4.0 mm	
Modes	Fluorescence and reflection (motorized filter changer)	
Filters	4-channel fluorescence Semrock LED-DA/FI/TR/Cy5-B-000 (Quadband) BrightLine [®] full- multiband filter set, optimized for DAPI, FITC, TRITC, & Cy5 and other like fluorophores, illuminated with LED-based light engines	

Arctis Cryo-Plasma-FIB technical highlights*		
Camera	Basler a2A4504-18umPRO wi	
Imaging FOV	>150 µm (diagonal)	
LED source	CoolLED, 4 channels (365 nm	
Vacuum system		
Vacuum system	Completely oil-free pumping s	
Vacuum chamber pressure (at cryo-conditions)	<5 × 10 ⁻⁵ Pa	
Cooling and shielding	Nitrogen-cooled Autoloader a System cryo-box	
Stage and sample holder		
Туре	CompuStage, computerized 4 Single axis specimen carrier h	
Eucentric point	10 mm (from electron column	
Compatible grid carriers	TomoGrids, AutoGrids, FIB-Au	
Sample loader	Autoloader: automated loading	
Protective coating		
Gas injection system	Retractable platinum GIS for c	
Conductive coating		
Sputtering	Retractable platinum-ion sput	
Environmental protection		
Enclosure	System fully enclosed	
Enclosure height	2.6 m	
Nitrogen cooling		
Nitrogen refilling	Automatic liquid nitrogen filling	

* Specifications subject to change without notice.

vith Sony IMX541 CMOS sensor (20.2 MP resolution)

m/450 nm/550 nm/635 nm)

system

and CompuStage with Thermo Scientific DualBeam™

4-axis specimen cryo-stage with ±90-degree alpha tilt holder for optimized stability and drift performance

n pole piece)

AutoGrids

ng of cassettes (up to 12 grid carriers) under cryo-conditions

chemical vapor deposition

Itter target for conductive sputter coating

ng system / Software controlled







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